

RoHS-Statement – Rev1.2

Helmond, 31-08-2020

The following statement applies to all unassembled printed circuit boards that we deliver. In accordance with the EU directive 2011/ 65/ EU and amendment 2015/ 863/ EU (RoHS III) restricted materials above the compulsory weight limit are not used in our products:

- Mercury (0.1 %) - Lead (0.1 %) - Cadmium (0.01 %) - Hexavalent chromium (0.1 %) - Polybrominated biphenyls (PBB) (0.1 %) - Polybrominated diphenyl ethers (PBDE) (e.g. pentaBDE and octaBDE) (0.1 %) - Phthalates DEHP, BBP, DBP, DIBP (0.1%)

A qualification is given for the use of lead with an express order of the printed circuit board with a HAL leaded (leaded hot air tinned) surface. The end product only conforms to the EU directive 2011/ 65/ EU if an applicable exemption is valid for the end product. RoHS-compliant soldering surfaces are naturally available in-house as an alternative. The halogenated flame retardant tetrabromobisphenol-A (TBBP-A) used in the base material is not a prohibited substance, especially as it no longer occurs in its original form in the printed circuit board (cured epoxy resin matrix) but has formed a new compound (reactive). This statement is also valid for China-RoHS 2 and Directive 2012/ 19/ EU (WEEE). **AQC BV** regularly monitors these directives for updates of and adapts declarations accordingly.


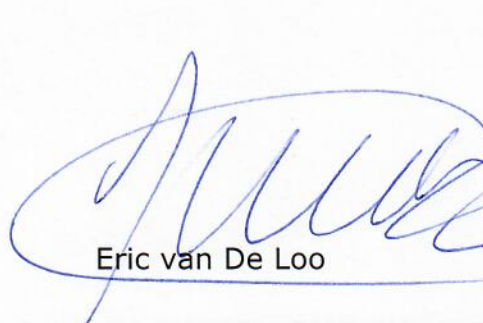
Please do not hesitate to contact us if you have any further questions.

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